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S/N 09/523,132

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	OKAZAKI ET AL.	Examiner:	B. LEE
Serial No.:	09/523,132	Group Art Unit:	2817
Filed:	MARCH 10, 2000	Docket No.:	10873.506US01
Title:	HIGH-FREQUENCY CIRCUIT ELEMENT		

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CERTIFICATE UNDER 37 CFR 1.10

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By:

Name:

[Signature]
James Larkin

AMENDMENT AND RESPONSE

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:



In response to the Office Action mailed August 14, 2002, please enter the following amendments and remarks.

In the Claims

Please amend claim 11 as follows:

11. (Thrice Amended) A high-frequency circuit element comprising:

a high-frequency circuit formed on said substrate,

a metal box with a lid electromagnetically shielding said high-frequency circuit by enclosing said substrate there within,

Sub D2
C1

C'
cont'd

input/output terminals placed on said metal box and inputting/outputting a high-frequency signal to/from said high-frequency circuit, said input/output terminals being connected to respective input/output lines of said high-frequency circuit, and covers for interrupting an unwanted higher order mode, surrounding the input/output lines, respectively, within an internal space of said metal box so as to suppress the propagation of high-frequency waves.
